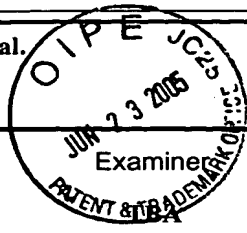


JPW

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT
(Under 37 CFR 1.97(b) or 1.97(c))

Docket No.
SEC.1127

In Re Application Of: Mu-kyeng Jung et al.



Application No.

10/824,399

Filing Date

04/15/2004

Examiner

Customer No.

20987

Group Art Unit

2811

Confirmation No.

5525

Title: **SEMICONDUCTOR DEVICE INCLUDING METAL INTERCONNECTION AND METAL RESISTOR AND METHOD OF MANUFACTURING THE SAME**

Address to:

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

37 CFR 1.97(b)

1. ☒ The Information Disclosure Statement submitted herewith is being filed within three months of the filing of a national application other than a continued prosecution application under 37 CFR 1.53(d); within three months of the date of entry of the national stage as set forth in 37 CFR 1.491 in an international application; before the mailing of a first Office Action on the merits, or before the mailing of a first Office Action after the filing of a request for continued examination under 37 CFR 1.114.

37 CFR 1.97(c)

2. ☐ The Information Disclosure Statement submitted herewith is being filed after the period specified in 37 CFR 1.97(b), provided that the Information Disclosure Statement is filed before the mailing date of a Final Action under 37 CFR 1.113, a Notice of Allowance under 37 CFR 1.311, or an Action that otherwise closes prosecution in the application, and is accompanied by one of:

☐ the statement specified in 37 CFR 1.97(e);

OR

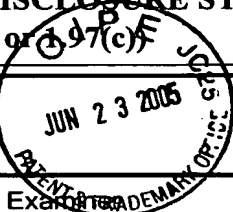
☐ the fee set forth in 37 CFR 1.17(p).

3. ☒ Also enclosed is a copy of a Korean Notice to Submit Response dated April 1, 2005, which was issued in connection with Korean Application No. 10-2003-0030510.

TRANSMITTAL OF INFORMATION DISCLOSURE STATEMENT
(Under 37 CFR 1.97(b) or 1.97(c))

Docket No.
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In Re Application: Mu-kyeng Jung et al.



Application No. 10/824,399	Filing Date 04/15/2004	Examination TBA	Customer No. 20987	Group Art Unit 2811	Confirmation No. 5525
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Title: SEMICONDUCTOR DEVICE INCLUDING METAL INTERCONNECTION AND METAL RESISTOR AND METHOD OF MANUFACTURING THE SAME

Payment of Fee

(Only complete if Applicant elects to pay the fee set forth in 37 CFR 1.17(p))

- ☐ A check in the amount of _____ is attached.
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Dated: JUNE 23, 2005

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